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FAN5646

Programmable Indicator “Soft” LED Blinker with TinyWire™ Single-Wire Interface

Features

- LED “Soft” Blink: with Logarithmic Fade Up and Fade Down for Power Savings
- Follow or Repeat Pattern Mode for Blinking when Applications Processor is Powered Down
- Default Pattern Optionally Modified using TinyWire™ Single-Wire Digital Control for:
 - LED Current Rise / Fall Time
 - t_{ON} and t_{OFF} for Up to Two Pulses
- High-Side Constant Current LED Driver:
 - 20 mA Maximum Output Current
 - 80 mV Drop-out at 20 mA I_{OUT}
 - External R_{SET} (SC70 only) or Internal Current Programming
- 35 μ A Operating Quiescent Current
- Short-Circuit, Under-Voltage, and Thermal Protections
- Wide Input Range: 2.7 to 5.5 V
- 4-Bump WLCSP, 0.4 mm pitch or 5-Lead SC70 (EIAJ SC88)

Applications

- Cell Phone
- Pocket PCs and Digital Cameras
- Bluetooth® Headsets PMP and MP3 players

Description

The FAN5646 is a flexible and compact solution for a blinking or “breathing” LED indicator. The internal programmable blink algorithm eliminates any need for continual system processor control. This means longer battery life for a hand-held system because the system processor is not awakened from sleep mode to blink an LED.

Very low dropout of 80 mV allows driving an LED without any inductors or switch capacitors. LED blink rate, rise and fall time, and CTRL line behavior can be programmed by a TinyWire™ single-wire digital interface. The on-time and time between pulses can be set for up to two different pulse widths.

The default for FAN5646 option 01 is “follow” mode, where the LED turns on with the programmed rise time, then stays on as long as CTRL remains HIGH. When CTRL falls, the LED turns off at the programmed fall time. For option 00; when CTRL is HIGH continuously, the LED repeats the programmed pattern.

The FAN5646 is available in a four-pin wafer-level chip-scale package with 0.4 mm pitch or a five-lead SC70 package.

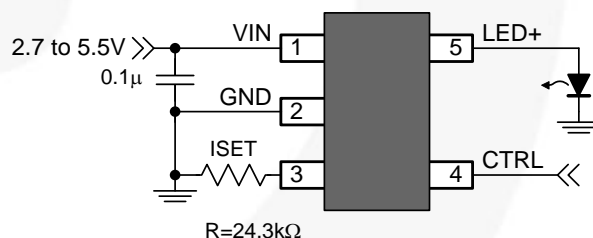


Figure 1. Typical Application

Ordering Information

Part Number	Option	Follow Bit Default	Temperature Range	Package	Packing
FAN5646UC00X	00	0	-40 to 85°C	WLCSP-4, 0.4mm Pitch	Tape and Reel
FAN5646S700X*	00	0	-40 to 85°C	5-Lead SC70, EIAJ SC88	Tape and Reel
FAN5646UC01X*	01	1	-40 to 85°C	WLCSP-4, 0.4mm Pitch	Tape and Reel
FAN5646S701X*	01	1	-40 to 85°C	5-Lead SC70, EIAJ SC88	Tape and Reel

* This device is End of Life. Please contact sales for additional information and assistance with replacement devices.

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Important: Contact a Fairchild Semiconductor sales representative for additional performance information and specifications.

Pin Configuration

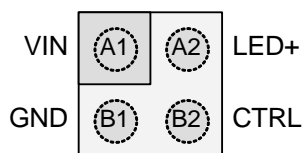


Figure 2. WLCSP – Top View: Bumps Facing Down

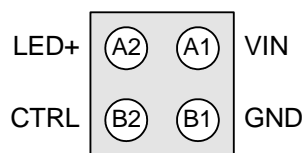


Figure 3. WLCSP – Bottom View: Bumps Facing Up

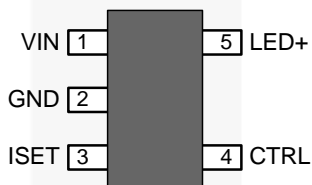


Figure 4. SC70-5 Top View

Pin Definitions

Pin #		Name	Description
WLCSP	SC70-5		
A1	1	VIN	Input Voltage. Connect to 2.7-5.5 V _{DC} input power source.
A2	5	LED+	LED Anode. LED current source output.
B1	2	GND	Ground.
B2	4	CTRL	Control pin. Logic input that controls programming and starts IC playback.
	3	ISET	LED Current Setting. Full-scale LED current is set by tying this pin through a resistor (R _{SET}) to GND. If this pin is left open, an internal current reference is used.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Units
V _{CC}	V _{IN} , LED+, CTRL Voltage		-0.3	6.0	V
	ISET Voltage		-0.3	V _{IN} + 0.3	V
ESD	Electrostatic Discharge Protection Level	Human Body Model per JESD22-A114	8.0		kV
		Charged Device Model per JESD22-C101	2.0		
T _J	Junction Temperature		−40	+150	°C
T _{STG}	Storage Temperature		−65	+150	°C
T _L	Lead Soldering Temperature, 10 Seconds			+260	°C

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter		Min.	Max.	Units
V _{IN}	Power Supply Voltage Range		2.7	5.5	V
T _A	Operating Ambient Temperature Range		-40	+85	°C
T _J	Operating Junction Temperature Range		-40	+125	°C
I _{LED(FS)}	Full-Scale LED Current	If I _{SET} is OPEN	5	20	mA
R _{SET}	R _{SET} Values for ±10% I _{SET} Accuracy ⁽¹⁾	CONTROL[7:6] = 00 I _{LED} = 7.2 mA to 2.5 mA	17.4	48.7	kΩ
		CONTROL[7:6] = 01 I _{LED} = 12.1 mA to 7.1 mA	20.5	34.8	
		CONTROL[7:6] = 10 I _{LED} = 17.3 mA to 12.3 mA	21.5	30.1	
		CONTROL[7:6] = 11 I _{LED} = 20.4 mA to 17.3 mA	24.3	28.7	

Note:

1. Applicable for SC70 version only.

Electrical Specifications

$V_{IN} = 2.7\text{ V to } 5.5\text{ V}$, $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$, $V_f = 1.8\text{ V to } [3.5\text{ V or } V_{IN} - 0.1\text{ V}]$, whichever is smaller. Typical values are at $T_A = 25^{\circ}\text{C}$, $V_{IN} = 3.6\text{ V}$, and $V_f = 2.5\text{ V}$.

Symbol	Parameter		Conditions	Min.	Typ.	Max.	Units	
Power Supplies								
I _{SD}	IDLE Mode Supply Current		V _{IN} = 3.6 V, CTRL = 0 V		0.30	0.75	μA	
I _{IN}	Quiescent Current		V _{IN} = 3.6 V, I _{LED} = 0 mA		35	80	μA	
I _{ACTIVE}	Active Mode Supply Current ⁽²⁾		V _{IN} = 3.6 V, LED+ = ON		220		μA	
V _{IH}	Logic Input Voltage HIGH			1.1			V	
V _{IL}	Logic Input Voltage LOW					0.4	V	
I _{IH}	Control Pin Input Current		CTRL = 1.8 V		1	250	nA	
V _{UVLO}	Under-Voltage Lockout Threshold		V _{IN} Rising		2.5		V	
			V _{IN} Falling		2.2		V	
Regulation								
I _{LED}	LED Output Current	I _{SET} OPEN	CONTROL[7:6] = 00	4.25	5.00	5.75	mA	
			CONTROL[7:6] = 01	8.70	10.00	11.30		
			CONTROL[7:6] = 10	13.20	15.00	16.80		
			CONTROL[7:6] = 11	18.00	20.00	22.00		
		R _{SET} = 24.3kΩ	CONTROL[7:6] = 00	4.70	5.00	5.30		
			CONTROL[7:6] = 01	9.40	10.00	10.60		
			CONTROL[7:6] = 10	14.10	15.00	15.90		
			CONTROL[7:6] = 11	18.80	20.00	21.20		
V _{ISET}	I _{SET} Drive Voltage		12.1 kΩ ≤ R _{SET} ≤ 100 kΩ			1.23		V
I _{OUT_RIPPLE}	Maximum LED Ripple Current ⁽²⁾		V _{IN} = 3.6 V, ΔV _{IN} = 700 mV, I _{LED} = 20 mA, t _{rise} = t _{fall} = 10 μs, t _{LOW} = 280 μs			0.5		% p-p
ΔI _{OUT_LOAD}	I _{OUT} Load Regulation		LED V _f = 1.8 to 3.45 V, V _{IN} = 3.6 V		-3		+3	%
ΔI _{OUT_LINE}	I _{OUT} Line Regulation		V _{IN} = 2.7 to 4.8 V, V _f = 2.5 V		-3		+3	%
V _{DROPOUT}	Dropout Voltage		I _{LED} = 20 mA, -10% I _{LED} Drop			80		mV
TSD	Thermal Shutdown		Rising Temperature at Junction			150		°C
			Hysteresis			20		
Timing								
f _{OSC}	Internal Oscillator Frequency		V _{IN} = 3.6 V		61	77	93	kHz
T _{OSC}	Oscillator Stability Over Temperature ⁽²⁾					±3		%

Note:

2. These parameters are guaranteed by design and characterization.

Typical Characteristics

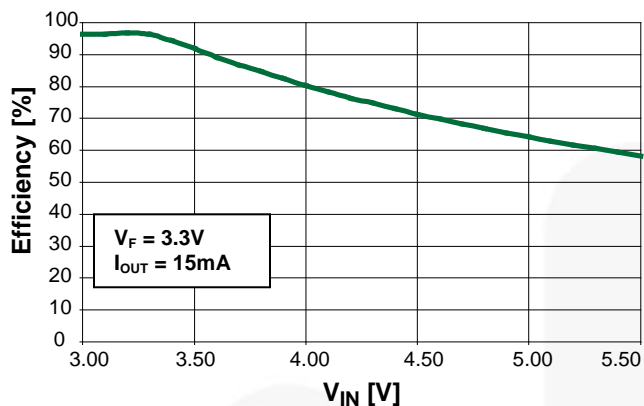


Figure 5. Efficiency at 25°C

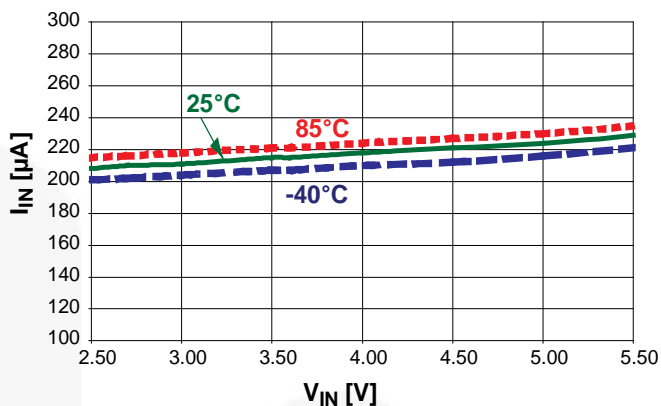


Figure 6. Active Mode Supply Current (LED+ = ON)

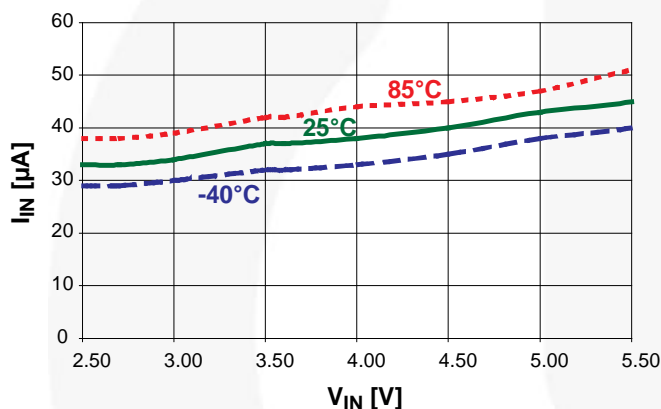
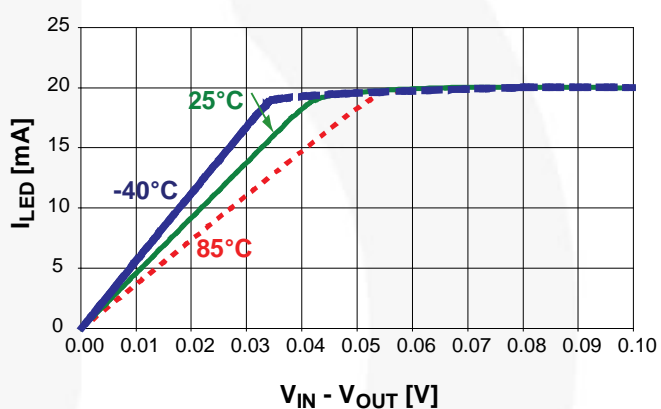
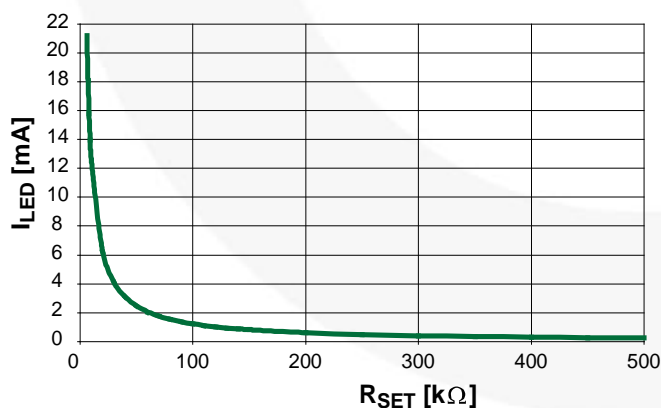
Figure 7. Quiescent Current ($I_{LED} = 0$ mA)

Figure 8. Output Current vs. Headroom Voltage

Figure 9. Output Current vs. R_{SET} at 25°C

Circuit Description

Operating Modes

At power up, the device is in IDLE (“sleep”) Mode until a rising edge of a CTRL signal is detected. When both the PLAY and FOLLOW bits are 0, the FAN5646 executes the LED pattern shown in Figure 10. If the length of the CTRL pulse is less than 1.7 s, only the initial pulse is seen. A CTRL pulse that is kept HIGH after the initial 1.7 s pulse causes the FAN5646 to go into PLAY mode where PULSE1 and PULSE2 are played as programmed in the registers (see Table 9).

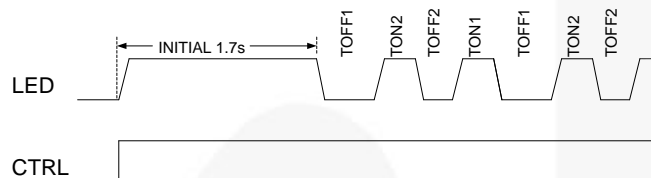


Figure 10. Initial Pulse Mode Timing

Table 1. CTRL Pin Operation, CONTROL[1:0] = 00

Mode	LED	Entry
IDLE	OFF	CTRL LOW for > 200 μ s
PLAY	Play Pattern	CTRL HIGH > 2 s
FOLLOW	Follows CTRL	CTRL HIGH < 2 s
Program	OFF	CTRL HIGH < 50 μ s

The behavior described in Table 1 can be changed using the PLAY and FOLLOW bits (see Table 3).

In PLAY Mode, the default pattern of PULSE1 repeats when CTRL is held HIGH while PULSE2 is always ignored (see Table 2). The FAN5646 plays the programmed sequence for blinking the LED until CTRL is set LOW. The programmed LED pattern always starts with PULSE1 and it can have t_{ON} and t_{OFF} times that are multiples of 106ms (see Equation (4)) while PULSE2 is disabled when its respective t_{ON} and t_{OFF} times are set to zero.

Table 2. PULSE1 Default Pattern – PLAY Mode

t_{RISE}	t_{FALL}	t_{ON}	t_{OFF}
516ms	516ms	533ms	1600ms

The IC creates the rise and fall profiles in Figure 11 by stepping through PWM dimming values given in Table 4 and Table 5. The SLEW1 and SLEW2 registers control the brightness of the LED for PULSE1 and PULSE2, respectively. In the example in Table 2, only the SLEW1 register is programmed with the brightness level for the LED.

In FOLLOW Mode, the LED+ pin is ON when CTRL is HIGH and, as such, follows the CTRL signal applied to FAN5646.

Play and Follow Bits

Table 3. PLAY and FOLLOW Bit Definition

PLAY	FOLLOW	Behavior
0	0	Default Behavior per Table 1*
0	1	LED Follows CTRL**
1	0	LED Enters PLAY Mode
1	1	LED Enters One-Shot Mode

One-Shot Mode

This mode is enabled when the PLAY and FOLLOW bits are both 1. One-Shot Mode is similar to PLAY mode except that PULSE1 is enabled while PULSE2 is always ignored. In One-Shot Mode, PULSE1 is played after CTRL is held HIGH for at least 200 μ s. Once PULSE1 is initiated, CTRL is ignored until PULSE1 is completed. If CTRL remains HIGH through the t_{OFF} time of PULSE1, PULSE1 continues to replay until CTRL is lowered. Therefore, One-Shot Mode enables the LED to blink in the programmed pattern as long as CTRL is HIGH.

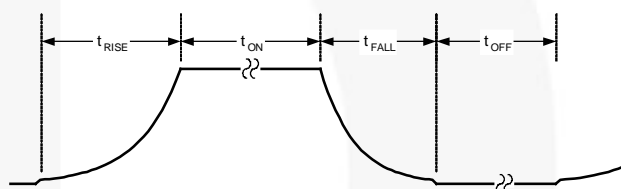


Figure 11. LED Average Current Profile

Table 4. Brightness Steps during Fade Up/Down (12.5%)

$I_{OUT(DC)} = 12.5\%$ of Full Scale			
Step #	t_{ON} (μ s)	t_{OFF} (μ s)	% of Full Power
0	0	3,333	0.00%
1	13	3,320	0.05%
2	65	3,268	0.24%
3	156	3,177	0.60%
4	299	3,034	1.10%
5	482	2,852	1.80%
6	716	2,617	2.70%
7	1,016	2,318	3.80%

* Default setting for FAN5646_00

** Default setting for FAN5646_01

Table 5. Brightness Steps During Fade Up/Down (100%)

$I_{OUT(DC)} = 100\%$ of Full Scale			
Step #	t_{ON} (μs)	t_{OFF} (μs)	% of Full Power
8	169	3,164	5.1%
9	221	3,112	6.6%
10	273	3,060	8.2%
11	339	2,995	10.2%
12	417	2,917	12.5%
13	495	2,839	14.8%
14	586	2,747	17.6%
15	677	2,656	20.3%
16	781	2,552	23.4%
17	885	2,448	26.6%
18	1,003	2,331	30.1%
19	1,133	2,201	34.0%
20	1,276	2,057	38.3%
21	1,419	1,914	42.6%
22	1,563	1,771	46.9%
23	1,732	1,602	52.0%
24	1,901	1,432	57.0%
25	2,070	1,263	62.1%
26	2,266	1,068	68.0%
27	2,461	872	73.8%
28	2,669	664	80.1%
29	2,878	456	86.3%
30	3,099	234	93.0%
31	3,333	0	100.0%

Changing the Default Values

The default values for the customer-accessible registers produce the fixed t_{ON} , t_{OFF} , t_{RISE} , and t_{FALL} illustrated in Table 2. These values can be changed using registers (see Table 9) accessible through the TinyWire™ single-wire interface.

The PLAY and FOLLOW control bits define the FAN5646 IC behavior (Table 1) of the CTRL line. In addition, the full-scale LED current can be changed (Table 6).

LED Full-Scale Current

The full-scale LED current can be set using the I_{SET} bits (CONTROL[7:6]) to accommodate a wide variety of LEDs.

When CTRL first goes HIGH, the IC determines if an R_{SET} is connected. If the I_{SET} is open or shorted to ground, I_{LED} is set by an internal reference according to Table 6:

Table 6. LED Maximum Current, WLCSP or I_{SET} Open

I_{SET} Bits	$I_{LED(MAX)}$ (mA)
00 ^{***}	5
01	10
10	15
11	20

I_{LED} can be programmed with an external R_{SET} resistor to GND in conjunction with the I_{SET} bits:

$$I_{LED} = \frac{K}{R_{SET} - 200} \quad \text{or} \quad (1)$$

$$R_{SET} = \frac{K}{I_{LED}} + 200$$

Table 7. LED Programming R_{SET}

I_{SET} Bits	K
00 ^{***}	123
01	246
10	369
11	492

R_{SET} should be between 12.1 kΩ and 100 kΩ, which corresponds to a range of 20 mA and 2.5 mA respectively when the I_{SET} bits are 01 and $I_{LED(max)} = 10$ mA. To achieve the highest accuracy using an external R_{SET} , program the I_{SET} bits for the I_{LED} closest to the desired I_{LED} based on the I_{SET} values in Table 6. Then calculate the appropriate R_{SET} for the desired I_{SET} using Equation (1) with the K value for the chosen I_{SET} bit value from Table 7.

RISE and FALL

The IC creates the rise and fall profiles in Figure 11 by incrementing or decrementing the PWM dimming value at a rate determined by the SLEW1 and SLEW2 registers. t_{RISE} or t_{FALL} are determined by the following equation:

$$t_{RISE} = 31 \times N_{RISE} \times 3.33\text{ms} \quad (2)$$

$$t_{FALL} = 31 \times N_{FALL} \times 3.33\text{ms} \quad (3)$$

where N_{RISE} and N_{FALL} are decimal values in the SLEW registers (Table 9). Therefore, the maximum time for rise or fall time to or from full current is:

$$t_{RISE/FALL} (\text{max}) = 1550\text{ms}$$

If the value of N_{RISE} or N_{FALL} is 0, the LED goes to (or from) off to full brightness with no brightness ramp. Therefore, the minimum time for controlled brightness stepping to full current ($N_{RISE} = 1$) is:

$$t_{RISE/FALL} (\text{min}) = 103 \text{ ms}$$

PULSE1 and PULSE2 have independently programmable t_{RISE} and t_{FALL} .

^{***} Default setting for the I_{SET} bits.

t_{ON} and t_{OFF}

The FAN5646 is capable of two pulses of different lengths with independently programmable t_{ON}, t_{RISE}, and t_{FALL}. The time between each of these pulses is established by t_{OFF}.

$$t_{ON} = (SLOW + 1) \times N_ON \times 106.6ms \quad (4)$$

$$t_{OFF} = (SLOW + 1) \times N_OFF \times 320ms \quad (5)$$

where SLOW is the value of the SLOW bit (CONTROL[2] – register), which is 1 or 0. N_ON and N_OFF values are PULSE1 and PULSE2 register values (Table 9).

Table 8. t_{ON} and t_{OFF} Maximum Values

	SLOW Bit	Maximum	Units
t _{ON}	0	1600	ms
t _{OFF}	0	4800	ms
t _{ON}	1	3200	ms
t _{OFF}	1	9600	ms

If t_{ON} is 0, the LED current ramps down immediately after attaining its FINAL value. The minimum t_{ON} and t_{OFF} for PULSE1 is 6.7 ms, while PULSE2 is disabled when either t_{ON} or t_{OFF} is 0.

If N_ON_PULSE2 and N_OFF_PULSE2 are both 0, only the t_{ON_PULSE1} and t_{OFF_PULSE1} are considered.

Table 9. Register Definition

Register	Address (Hex)	Default (Hex)	7	6	5	4	3	2	1	0
SLEW1	0	55	NRISE1: Duration of each brightness level during LED turn-on				NFALL1: Duration of each brightness level during LED turn-off			
PULSE1	1	55	N_ON1: Duration the LED stays on at 100% brightness				N_OFF1: Duration the LED stays off after ramping down			
SLEW2	2	55	NRISE2: Duration of each brightness level during LED turn-on				NFALL2: Duration of each brightness level during LED turn-off			
PULSE2	3	00	N_ON2: Duration the LED stays on at 100% brightness				N_OFF2: Duration the LED stays off after ramping down			
CONTROL	4	00 ⁽³⁾ 01 ⁽⁴⁾	I _{SET}		RESERVED			SLOW	PLAY	FOLLOW

Notes:

3. Default value for FAN5646_00.

4. Default value for FAN5646_01.

Programming Examples

The example in Table 10 and Figure 12 illustrates the relationship between the default register contents and the pattern of the IC in PLAY mode. **BOLD** signifies the decimal values of the controlling registers.

Table 10. PULSE1 Default Example (see Table 2 and Table 9)

$t_{\text{FALL1}} = t_{\text{RISE1}} = 31 \times \mathbf{5} \times 3.33 \text{ ms} = 516 \text{ ms}$
$t_{\text{ON1}} = \mathbf{5} \times 106.6 \text{ ms} = 533 \text{ ms}$
$t_{\text{OFF1}} = \mathbf{5} \times 320 \text{ ms} = 1600 \text{ ms}$

Register	SLEW1	PULSE1	SLEW2	PULSE2	CONTROL
Value (HEX)	55	55	00	00	02

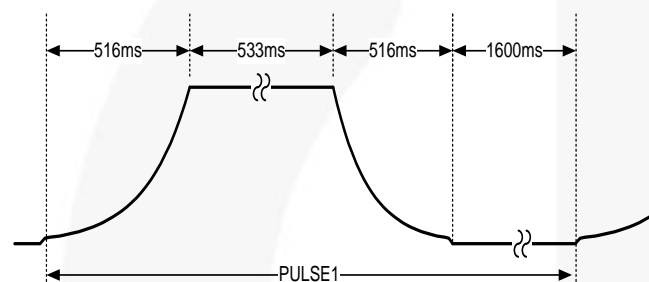


Figure 12. PULSE1 Default LED Current Pattern for Register in Table 10

The example in Table 11 and Figure 13 illustrates a long-duration pulse followed by a short-duration pulse with two seconds between each pulse; with rise and fall times of each using default values.

Table 11. Long-Short Pattern Example (see Figure 13)

$t_{\text{FALL1}} = t_{\text{RISE1}} = 31 \times \mathbf{5} \times 3.33 \text{ ms} = 516 \text{ ms}$
$t_{\text{ON1}} = \mathbf{10} \times 106.6 \text{ ms} = 1066 \text{ ms}$
$t_{\text{OFF1}} = \mathbf{9} \times 320 \text{ ms} = 2880 \text{ ms}$
$t_{\text{FALL2}} = t_{\text{RISE2}} = 31 \times \mathbf{1} \times 3.33 \text{ ms} = 103 \text{ ms}$
$t_{\text{ON2}} = \mathbf{2} \times 106.6 \text{ ms} = 213 \text{ ms}$
$t_{\text{OFF2}} = \mathbf{5} \times 320 \text{ ms} = 1600 \text{ ms}$

Register	SLEW1	PULSE1	SLEW2	PULSE2	CONTROL
Value (HEX)	55	A9	11	25	02

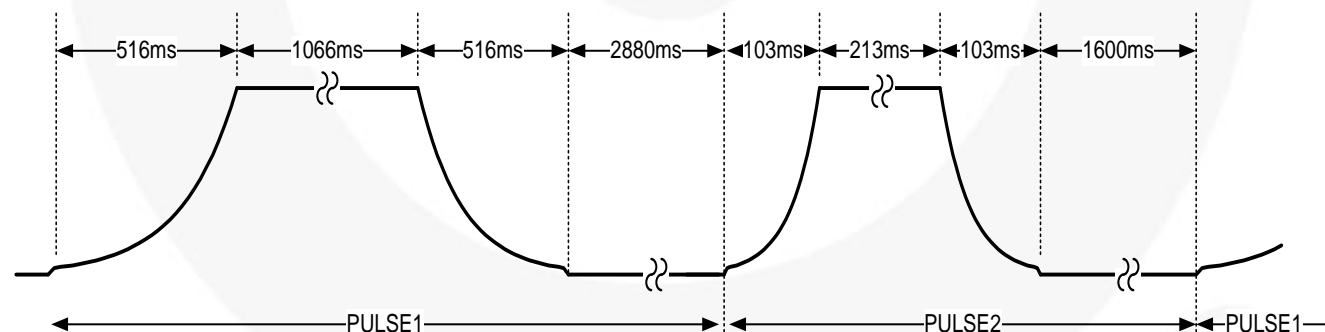


Figure 13. LED Current Waveform for Register Settings in Table 11

TinyWire™ Digital Interface

TinyWire is a flexible, general-purpose, binary protocol designed to minimize the number of pins on the IC while providing a complete digital interface that can be driven from any microcontroller or applications processor using “bit banging” on a general-purpose I/O pin. The interface's speed and flexibility accommodate a wide range of processor clock capabilities. The fully static nature of the interface requires that the applications processor dedicate only sufficient uninterrupted attention to bit banging to complete a single packet. Interrupted packets are ignored and may be subsequently retransmitted.

The CONTROL word contains the address of the register that receives the data, followed by the data to be written. The CONTROL word is shifted LSB first on the CTRL line, as shown in Figure 14. The TinyWire protocol operates over a wide range of t_{BIT} times (see Table 13), allowing encoding of the brightness control bit-stream using a microcontroller software “bit-bang” loop.

The CONTROL word begins with the rising edge of CTRL. If CTRL is HIGH for a greater percentage of the time than it is LOW between rising edges, the bit is a 1. Conversely, if CTRL is LOW longer than it is HIGH, the bit is a 0. Observe the following timing rules to ensure proper data transmission:

Table 12. Data Bit Definition

BIT =	t_{LOW}	t_{HIGH}
0	$\geq 75\% t_{\text{BIT}}$	$\leq 25\% t_{\text{BIT}}$
1	$\leq 25\% t_{\text{BIT}}$	$\geq 75\% t_{\text{BIT}}$

Table 13. Timing Requirements

	Minimum	Maximum
t_{LOW}	500 ns	40 μs
t_{HIGH}	500 ns	40 μs
t_{RESET}	200 μs	

Data is written to the selected register at the rising edge of the STOP bit. A new CONTROL word may start within 4 μs of the falling edge of the STOP bit.

As indicated in Table 1, if CTRL remains LOW for at least t_{RESET} after the falling edge of the STOP bit, the IC reverts to its IDLE state.

If CTRL remains HIGH for at least t_{RESET} , the IC executes its programmed commands.

CONTROL Word

The CONTROL word contains the address of the register to receive the data followed by the data to be written. The FAN5646 data transfer is an 11-bit word, with the first three bits (0 through 2) being the register address, LSB first. The next eight bits (3 through 10) are the data to be written to the selected register, LSB first. Data is latched into the selected register at the rising edge of the STOP bit. A new word may be transferred to the IC as little as 4 μs after the falling edge of the STOP bit.

Table 14 shows the CONTROL word structure as well as an example of writing 23H into register 2 ($A[2:0] = 010$).

Table 14. Address and Data Word

BIT	0	1	2	3	4	5	6	7	8	9	10
Value	A0	A1	A2	D0	D1	D2	D3	D4	D5	D6	D7
Example	0	1	0	1	1	0	0	0	1	0	0

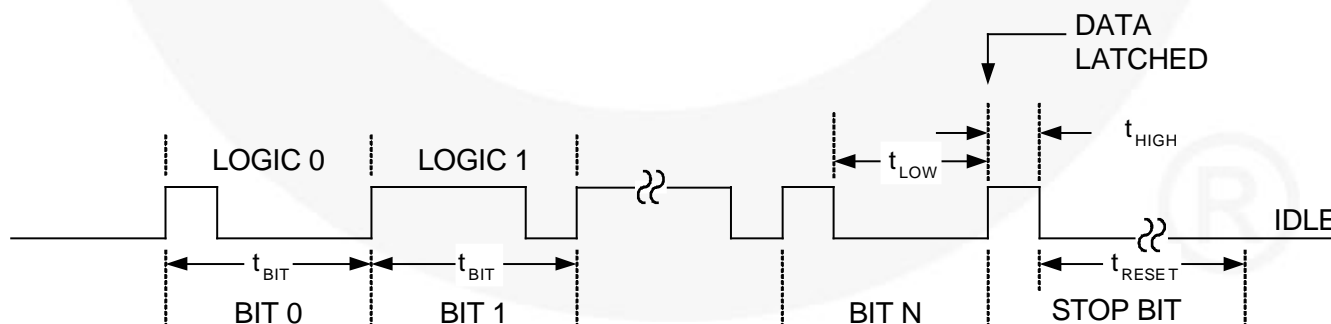
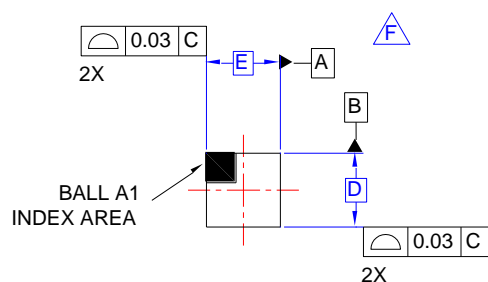
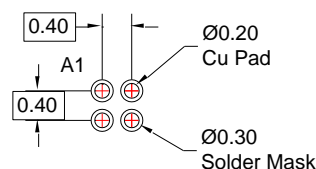
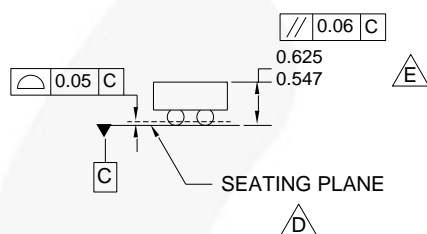


Figure 14. TinyWire™ Protocol

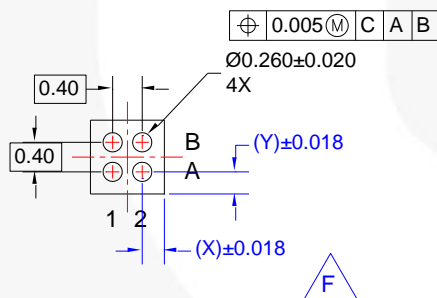
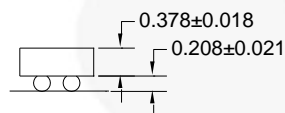
Physical Dimensions



TOP VIEW

RECOMMENDED LAND PATTERN
(NSMD PAD TYPE)

SIDE VIEWS



BOTTOM VIEW

NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASME Y14.5M, 1994.
- D. DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- E. PACKAGE NOMINAL HEIGHT IS 586 MICRONS ±39 MICRONS (547-625 MICRONS).
- F. FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
- G. DRAWING FILNAME: MKT-UC004ACrev2.

Figure 15. 4-Bump WLCSP, 0.4 mm Pitch

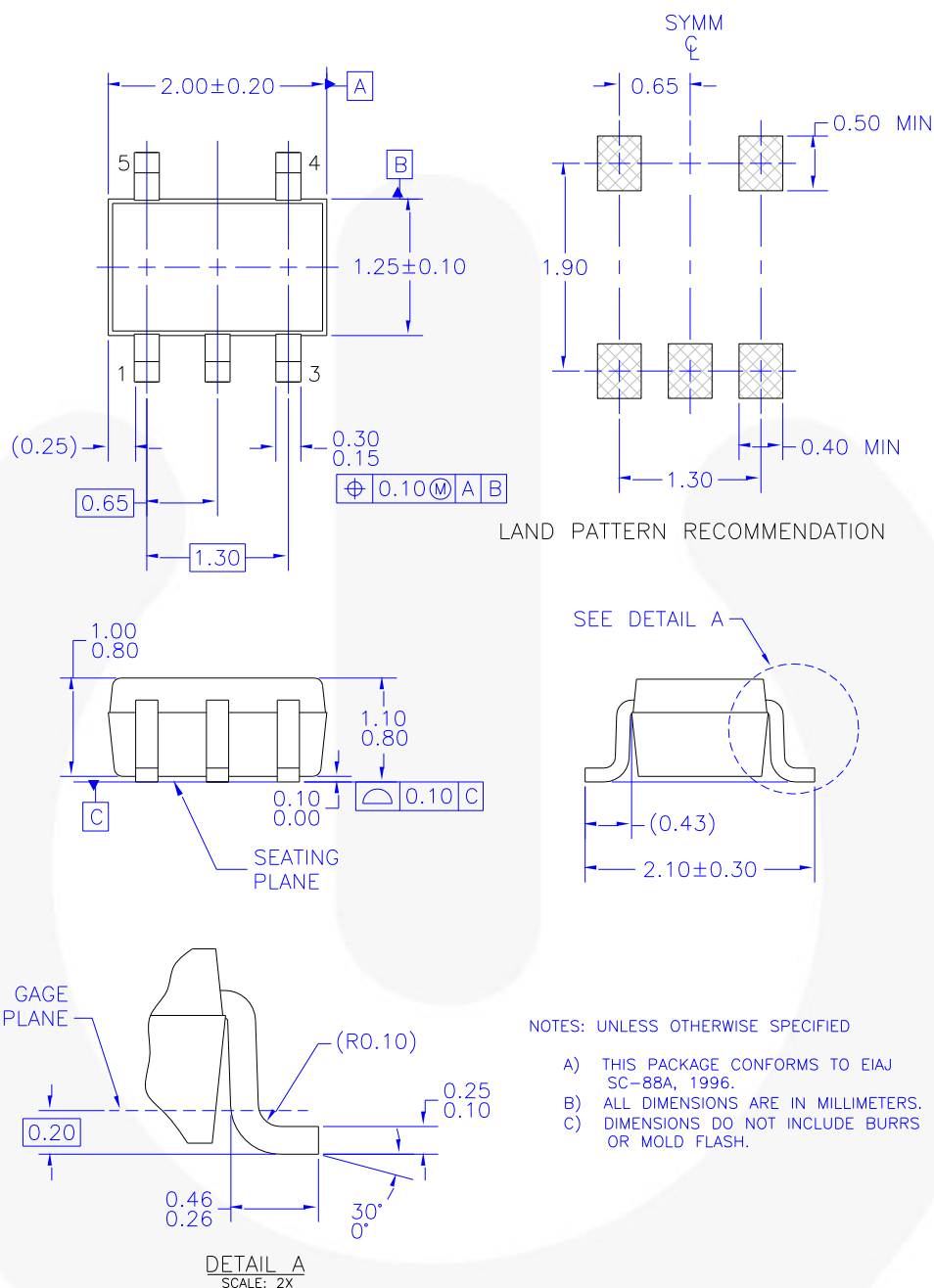
Product-Specific Dimensions

Product	D	E	X	Y
FAN5646UC	0.820 mm	0.820 mm	0.210 mm	0.210 mm

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Physical Dimensions (Continued)



MAA05AREV5

Figure 16. 5-Lead SC70 (EIAJ SC88)





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